onsemi

MOSFET - Power, Single N-Channel

100 V, 65 mΩ, 13 A

NVTFS070N10MCL

Features

- Small Footprint (3.3 x 3.3 mm) for Compact Design
- Low RDS(on) to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- NVTFWS070N10MCL Wettable Flanks Product
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Parameter Symbol Value Unit V Drain-to-Source Voltage 100 VDSS V Gate-to-Source Voltage VGS ±20 Continuous Drain A T_C = 25°C I_D 13 Current R_{0JC} (Notes 1, 2, 3) $T_C = 100^{\circ}C$ 9.0 Steady State Power Dissipation $T_{\rm C} = 25^{\circ}{\rm C}$ P_D 25 W R_{0JC} (Notes 1, 2) $T_{\rm C} = 100^{\circ}{\rm C}$ 12 Continuous Drain 4.5 $T_A = 25^{\circ}C$ I_D А Current $R_{\theta JA}$ (Notes 1, 2, 3) $T_A = 100^{\circ}C$ 32 Steady State Power Dissipation $T_A = 25^{\circ}C$ P_{D} 2.9 W R_{0JA} (Notes 1, 2) $T_{\Delta} = 100^{\circ}C$ 1.5 **Pulsed Drain Current** 47 $T_{C} = 25^{\circ}C, t_{p} = 10 \ \mu s$ A IDM –55 to °C Operating Junction and Storage Temperature T_J, T_{stg} Range +175 Single Pulse Drain-to-Source Avalanche 423 EAS mJ Energy $(I_{L(pk)} = 0.5 A)$ Lead Temperature for Soldering Purposes °C T_L 260 (1/8" from case for 10 s) Source Current (Body Diode) ls 19 A

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{\theta JC}$	6.0	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	51	

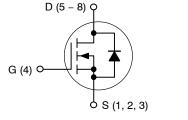
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

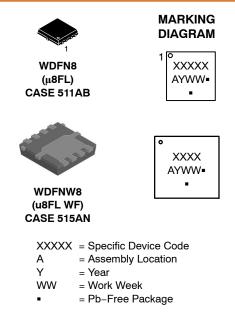
2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
100 V	65 mΩ @ 10 V	13 A
100 V	90 mΩ @ 4.5 V	13 A







ORDERING INFORMATION

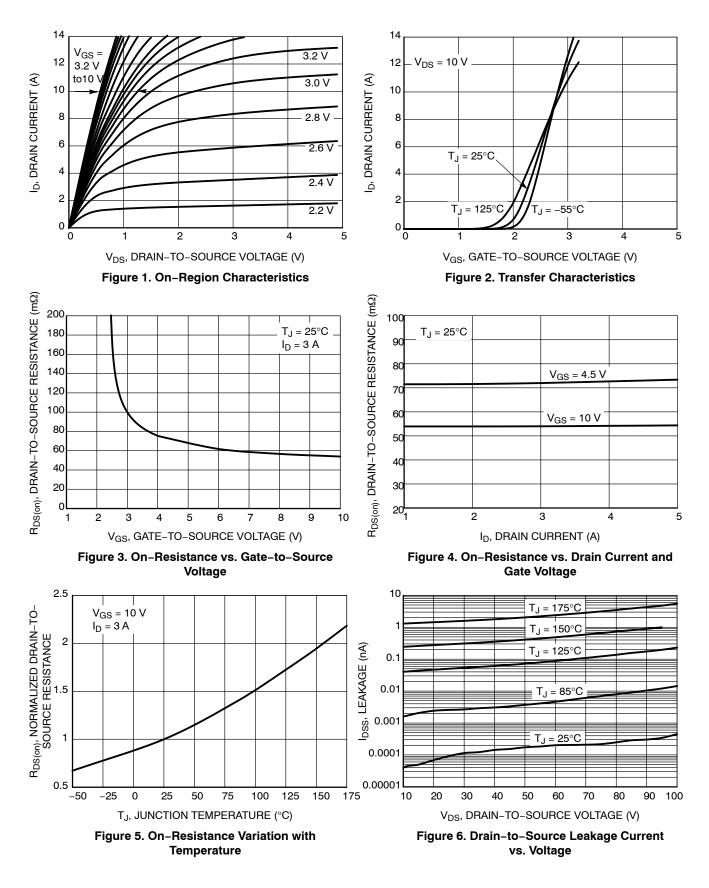
See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

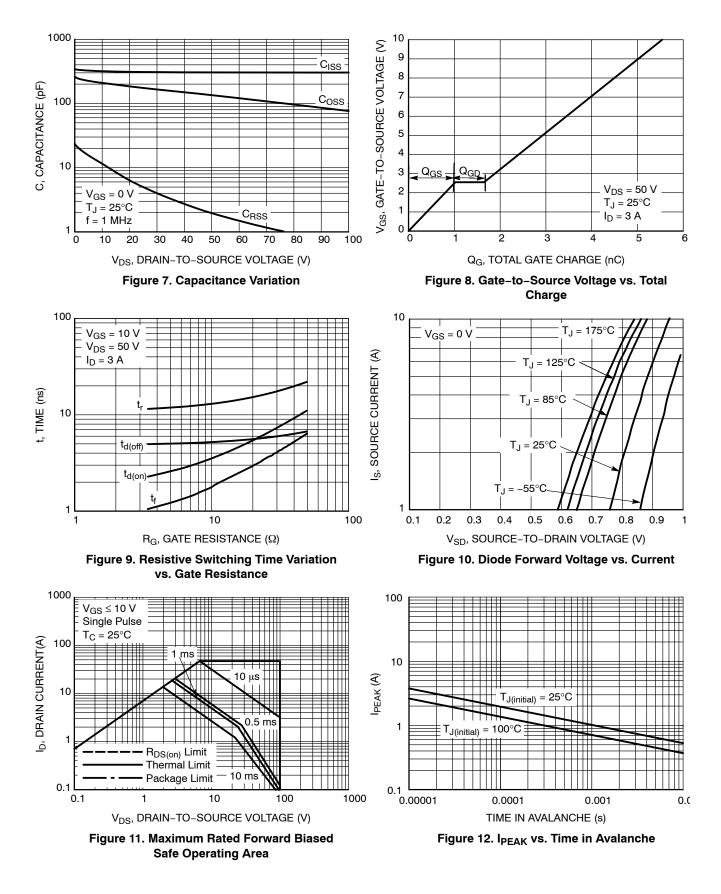
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS						-	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		100			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				67		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			1.0	
		V _{DS} = 100 V	T _J = 125°C			100	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	_S = 20 V			100	nA
ON CHARACTERISTICS (Note 4)						-	
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 15 \mu A$		1.0		3.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.2		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 3 A		54	65	
		V _{GS} = 4.5 V	I _D = 2 A		72	90	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 10 V, I	_D = 3 A		11		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 50 V			305		
Output Capacitance	C _{OSS}				135		pF
Reverse Transfer Capacitance	C _{RSS}				1.9		
Total Gate Charge	Q _{G(TOT)}				2.7		nC
					5.5		
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 50 V; I _D = 3 A			0.6		
Gate-to-Source Charge	Q _{GS}				1.0		nC
Gate-to-Drain Charge	Q _{GD}				0.6		
Plateau Voltage	V _{GP}				2.6		V
SWITCHING CHARACTERISTICS (Note 5	5)						
Turn-On Delay Time	t _{d(ON)}				5.1		
Rise Time	tr	V _{GS} = 10 V, V _D	s = 50 V.		1.3		1
Turn-Off Delay Time	t _{d(OFF)}	$V_{GS} = 10 \text{ V}, V_{DS} = 30 \text{ V},$ $I_D = 3 \text{ A}, R_G = 6 \Omega$			12.1		ns
Fall Time	t _f				2.8		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V$, $I_{S} = 3 A$, $T_{J} = 25^{\circ}C$			0.84	1.3	V
5		V _{GS} = 0 V, I _S = 3 A	, T _J = 125°C		0.72		
Reverse Recovery Time	t _{RR}	VGS = 0 V, di/dt = 100 A/ μ s, I _S = 1 A			19		ns
Reverse Recovery Charge	Q _{RR}				8		nC
Charge Time	ts				9		
Discharge Time	t _D				10		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

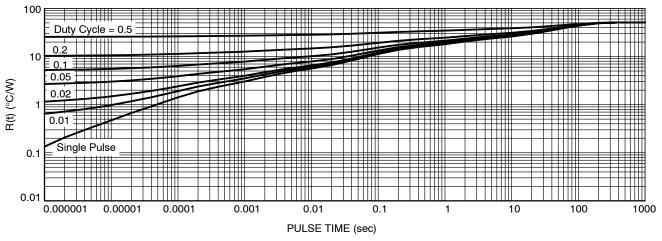


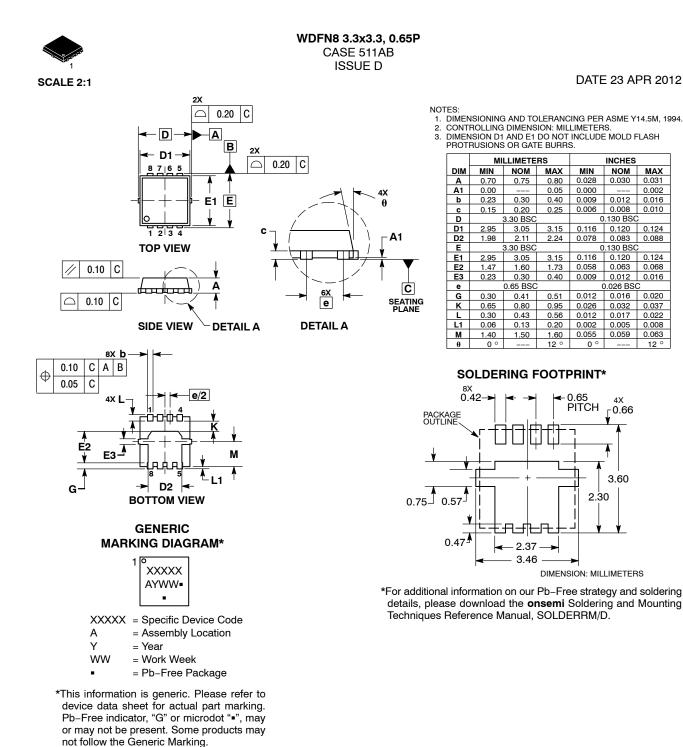
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVTFS070N10MCLTAG	70L1	WDFN8 (Pb-Free)	1500 / Tape & Reel
NVTFWS070N10MCLTAG	70W1	WDFN8 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





 DOCUMENT NUMBER:
 98AON30561E
 Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.

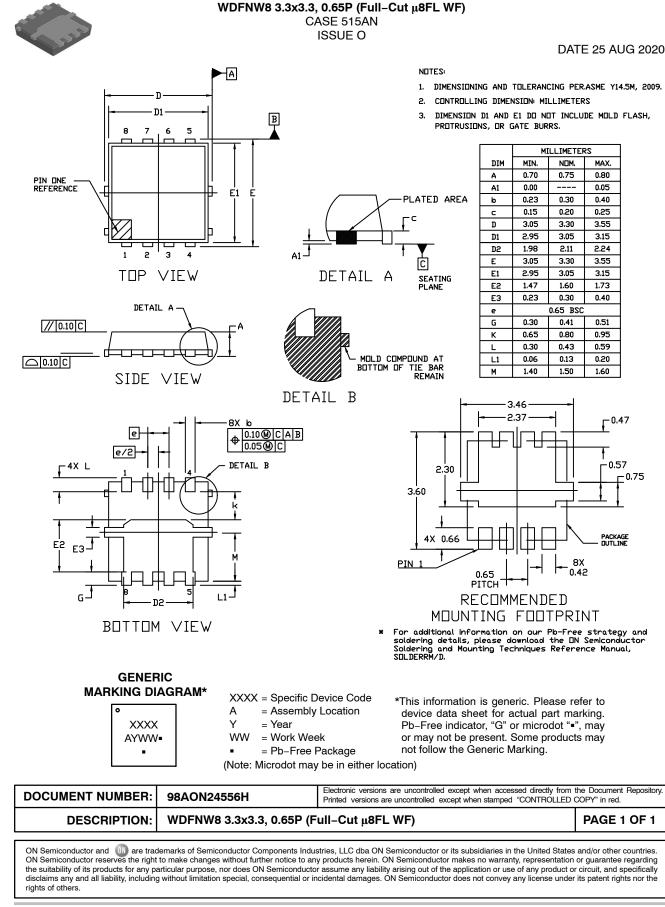
 DESCRIPTION:
 WDFN8 3.3X3.3, 0.65P
 PAGE 1 OF 1

 onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation

special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

© Semiconductor Components Industries, LLC, 2019





© Semiconductor Components Industries, LLC, 2018

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>